
2SC1162

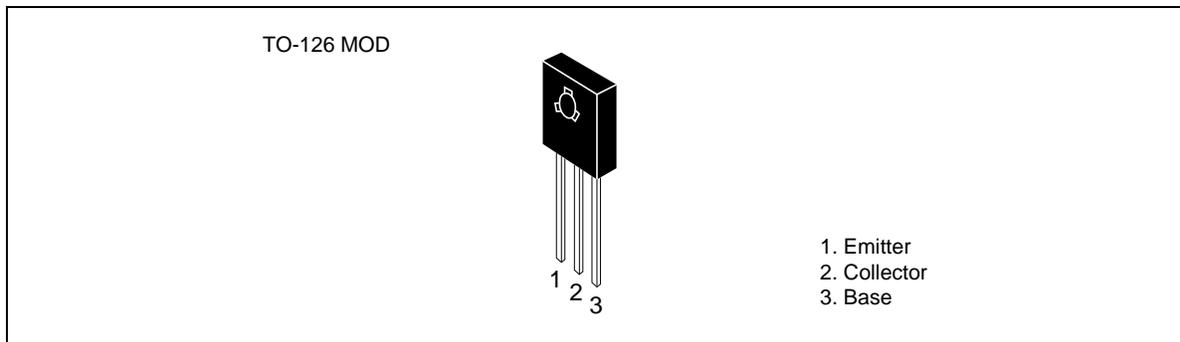
Silicon NPN Epitaxial

HITACHI

Application

Low frequency power amplifier complementary pair with 2SA715

Outline



Absolute Maximum Ratings (T_a = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	35	V
Collector to emitter voltage	V _{CEO}	35	V
Emitter to base voltage	V _{EBO}	5	V
Collector current	I _C	2.5	A
Collector peak current	I _{C(peak)}	3	A
Collector power dissipation	P _C	0.75	W
	P _C ^{*1}	10	W
Junction temperature	T _j	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

Note: 1. Value at T_c = 25°C.

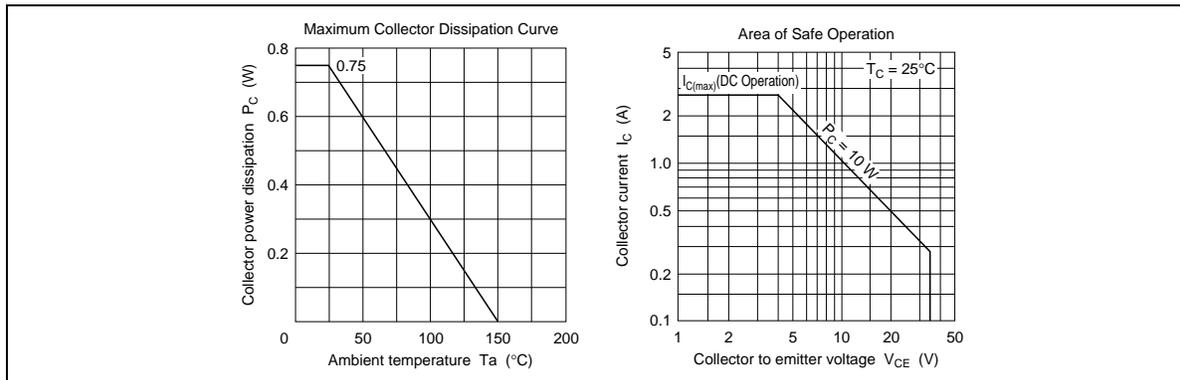
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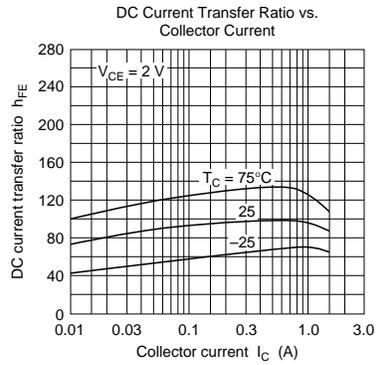
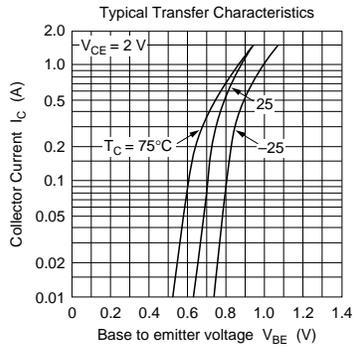
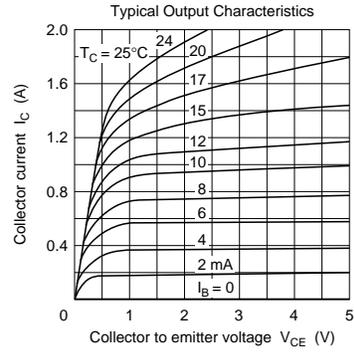
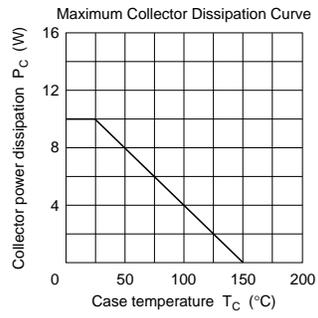
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	35	—	—	V	$I_C = 1 \text{ mA}, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	35	—	—	V	$I_C = 10 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	—	—	V	$I_E = 1 \text{ mA}, I_C = 0$
Collector cutoff current	I_{CBO}	—	—	20	μA	$V_{CB} = 35 \text{ V}, I_E = 0$
DC current transfer ratio	h_{FE}^{*1}	60	—	320		$V_{CE} = 2 \text{ V}, I_C = 0.5 \text{ A}$
	h_{FE}	20	—	—		$V_{CE} = 2 \text{ V}, I_C = 1.5 \text{ A}$ (pulse test)
Base to emitter voltage	V_{BE}	—	0.93	1.5	V	$V_{CE} = 2 \text{ V}, I_C = 1.5 \text{ A}$ (pulse test)
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	0.5	1.0	V	$I_C = 2 \text{ A}, I_B = 0.2 \text{ A}$ (pulse test)
Gain bandwidth product	f_T	—	180	—	MHz	$V_{CE} = 2 \text{ V}, I_C = 0.2 \text{ A}$

Note: 1. The 2SC1162 is grouped by h_{FE} as follows.

B	C	D
60 to 120	100 to 200	160 to 320





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